

SE2576L: 2.4 GHz High Power Wireless LAN Power Amplifier

Applications

- IEEE802.11b DSSS WLAN
- IEEE802.11g,n OFDM WLAN
- Access Points

Features

- Dual Mode IEEE802.11b, IEEE802.11g, IEEE802.11n
- 26 dBm, EVM = 3%, 802.11g, OFDM 54 Mbps
- 29 dBm, 802.11b mask compliant
- Integrated PA, Input Match, 2.8V reference voltage generator
- Integrated Temperature Compensated, Positive Slope Power Detector
- Pb-free, RoHS compliant and Halogen-free
- 3 mm x 3 mm x 0.9 mm, MSL 3

Product Description

The SE2576L is a high power 802.11bgn WLAN power amplifier module providing the functionality of the power amplifier, power detector, reference voltage generator and input match.

The SE2576L is designed for ease of use and maximum flexibility, with an integrated input match, and external output match to adjust the load line for 5V, 26dBm operation.

The SE2576L includes a temperature compensated transmit power detector with over 20 dB of dynamic range and <1.2dB variation under 3:1 mismatch at the antenna.

The SE2576L includes a digital enable control due to an integrated reference voltage generator. The power ramp rise/fall time is 0.5 µs typical.

Ordering Information

Part No.	Package	Remark
SE2576L	16 pin QFN	Samples
SE2576L-R	16 pin QFN	Tape & Reel
SE2576L-EK1	N/A	Evaluation kit

Functional Block Diagram

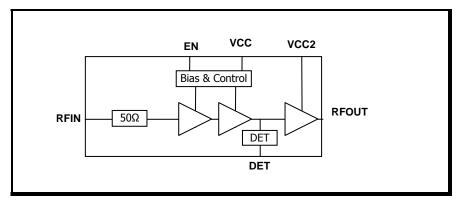


Figure 1: Functional Block Diagram



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Pin Out Diagram NC C 16 15 14 13 RFIN 12 GND **Ground Paddle** EN 2 11 **RF OUT** 10 GND 3 **RF OUT** 4 9 VCC0 GND 5 6 7 8 DET N C

Figure 2: SE2576L Pin Out (Top View Through Package)

Pin Out Description

Pin No.	Name	Description
1	RF IN	RF Input
2	EN	Power Amplifier Enable
3	GND	Ground
4	VCC0	Power Supply for Bias Circuit
5	GND	Ground
6	GND	Ground
7	DET	Power Detector Output
8	NC	No Connect. May be left floating or grounded.
9	GND	Ground
10	RF OUT	RF Output
11	RF OUT	RF Output
12	GND	Ground
13	VCC2	Power Supply for 2 nd Stage
14	NC	No Connect. May be left floating or grounded.
15	VCC1	Power Supply driver stages
16	GND	Ground
Die paddle	GND	Ground



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Absolute Maximum Ratings

These are stress ratings only. Exposure to stresses beyond these maximum ratings may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition	Min.	Max.	Unit
VCC0, 1, 2	Supply Voltage on VCC	-0.3	5.5	V
Vin	DC input on EN	-0.3	3.6	V
TX	RF Input Power. RF Out terminated in 50Ω	-	12.0	dBm
TA	Operating Temperature Range	-40	85	°C
Тѕтс	Storage Temperature Range	-40	150	°C
ESD _{HBM}	JEDEC JESD22-A114 all pins	-	1000	V

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
TA	Ambient temperature	-40	25	85	°C
VCC	Supply voltage, relative to GND = 0 V	4.5	5	5.5	V

DC Electrical Characteristics

Conditions: VCC = 5 V, EN = V_{ENH}, T_A = 25 °C, as measured on Skyworks Solutions' SE2576L-EV1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Icc-g	Total Supply Current	POUT = 26 dBm, 54 Mbps OFDM signal, 64QAM	-	500	-	mA
Ісс-в	Total Supply Current	P _{OUT} = 29 dBm, 11 Mbps CCK signal, BT = 0.45	-	650	-	mA
Icc_off	Total Supply Current	EN = 0 V, No RF Applied	-	10	100	μΑ

Logic Characteristics

Conditions: VCC = 5 V, EN = V_{ENH}, T_A = 25 °C, as measured on Skyworks Solutions' SE2576L-EV1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VENH	Logic High Voltage (Module On)	-	1.8	-	3.6	V
VENL	Logic Low Voltage (Module Off)	-	0	-	0.4	V
lenh	Input Current Logic High Voltage	-	ı	300	ı	μΑ
IENL	Input Current Logic Low Voltage	$V_{EN} = 0.4V$	-	1	50	μΑ



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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Z _{EN}	Enable pin input impedance	Passive Pull Down		10		kΩ

AC Electrical Characteristics

802.11g/n Transmit Characteristics

Conditions: VCC = 5 V, EN = 3.3 V, T_A = 25 °C, as measured on Skyworks Solutions' SE2576L-EV1 evaluation board (de-embedded to device), all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fin	Frequency Range	-	2400	-	2500	MHz
		54 Mbps OFDM signal, 64 QAM, 3% EVM	-	26	-	
POUT	Output Power	1 Mbps CCK signal, BT = 0.045, Mask		29		dBm
	Capati one.	802.11n, HT20, all data rates, Mask		30		<u> </u>
		802.11n, HT40, all data rates, Mask		27		
P _{1dB}	P1dB	-	ı	32	ı	dBm
S ₂₁	Small Signal Gain	-	30	33	ı	dB
Δ\$21	Small Signal Gain Variation	Gain variation over single 40MHz channel	-	0.5	-	dB
	variation	Gain Variation over band	-	1.0	-	
2f	Harmonics P	Роит = 29 dBm, 1 Mbps,	-	-50	-45	dBm/MHz
3f	Tiamonics	802.11b	-	-50	-45	dBm/MHz
tdr, tdf	Delay and rise/fall Time	50 % of Ven edge and 90/10 % of final output power level	ı	0.5	ı	μs
S ₁₁	Input Return Loss	-	10	15	-	dB
STAB	Stability	CW, Pout = 29 dBm 0.1 GHz - 20 GHz Load VSWR = 4:1	All non-harmonically related outputs less than -42 dBm/MHz		outs less than	
RU	Ruggedness	CW 50% duty cycle, PIN = +12dBm, Load VSWR = 6:1	No permanent damage.			



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Power Detector Characteristics

Conditions: VCC = 5 V, EN = VENH, TA = 25 °C, as measured on Skyworks Solutions' SE2576L-EV1 evaluation board, unless otherwise noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fouт	Frequency Range	-	2400	-	2500	MHz
PDR	Power detect range, CW	Measured at RF out	5	-	30	dBm
PDZsrc	DC source impedance on PD_OUT	-	-	2.3	-	ΚΩ
PDZLOAD	DC load impedance	-	-	26.5	-	ΚΩ
PDV _{P5}	Output Voltage, Pout = 5dBm CW	Measured into 26.5KΩ	-	0.33	-	٧
PDV _{P26}	Output Voltage, Pout = 26 dBm CW	Measured into 26.5KΩ	-	0.70	-	٧
PDV _{P30}	Output Voltage, Pout = 30 dBm CW	Measured into 26.5KΩ	-	1.00	-	V
LPF-3dB	Power detect low pass filter -3dB corner frequency	Measured into 26.5KΩ	-	2.0	-	MHz

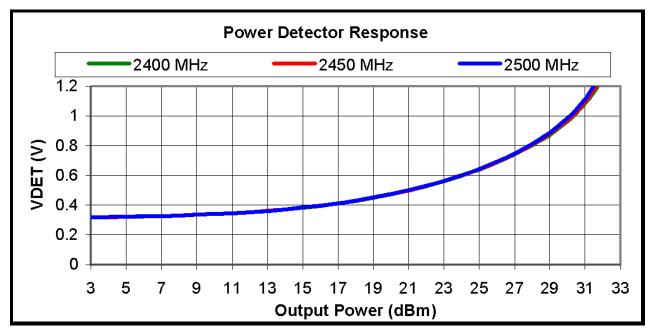


Figure 3: SE2576L Detector Characteristics



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Package Diagram

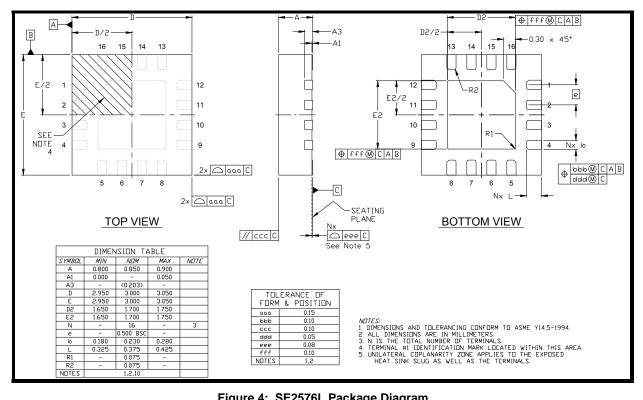


Figure 4: SE2576L Package Diagram



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Recommended Land and Solder Patterns

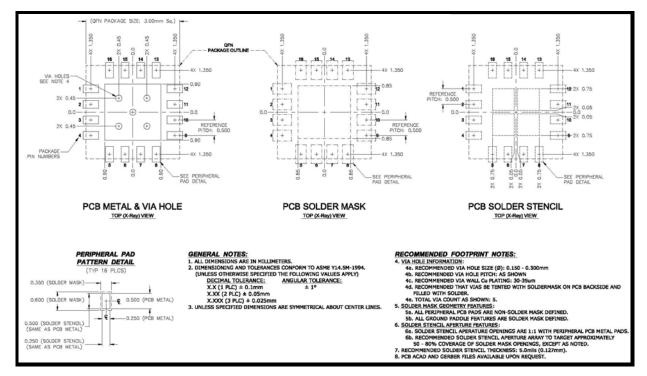
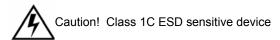


Figure 5: SE2576L Recommended Land and Solder Pattern

Package Handling Information

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE2576L is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "Quad Flat No-Lead Module Solder Reflow & Rework Information", Document Number QAD-00045
- "Handling, Packing, Shipping and Use of Moisture Sensitive QFN", Document Number QAD-00044





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Branding Information

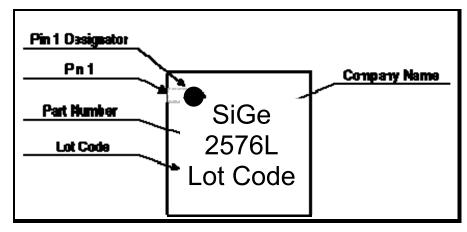


Figure 6: SE2576L Branding

Tape and Reel Information

Parameter	Value		
Devices Per Reel	3000		
Reel Diameter	13 inches		
Tape Width	12 millimeters		
pin 1 corner			
	000000		
Product Code List Number Product Code List Number List Number List Number List Number List Number List Number	Product Code Let Number Let Number		

Figure 7: SE2576L-R Tape and Reel Information

Document Change History

Revision	Date	Notes
1.0	Jan 10, 2009	Created
1.1	May 8, 2009	Updated PA Control Logic Characteristics Updated POD for SE2576L datasheet.
1.2	Jul 8, 2009	Updated to correct pins 8 & 14 definitions.
1.3	Aug 2, 2009	Updated detector characteristics
1.4	Sep 24, 2009	Updated current consumption
1.5	Oct 25, 2009	Updated detector plot
1.6	Jan 25, 2010	Updated Off-State Leakage current



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Revision	Date	Notes
1.7	Jun 22, 2010	Extended operating temperature to Industrial limits
1.8	Dec 18, 2010	Updated ESD rating Added OFDM Mask Compliance
1.9	Apr 10, 2012	Updated with Skyworks logo and disclaimer statement

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